
Preface

The series of papers presented in this issue of the Journal of Thermal Analysis and Calorimetry include papers based on presentations made at the Canadian Thermal Analysis Society meeting of May 17-18, 2005.

I sincerely thank all the authors for submitting such high quality papers and, most importantly, for their timely responses to the reviewers comments. Each paper was reviewed by two independent referees, all of whom are listed on the next page. I am grateful to these referees for the time and effort that they put into the review process.

I especially wish to thank those authors who prompted this editor for this issue into action on several occasions.

Dr. David E. G. Jones

Acknowledgements

The Guest Editor is very grateful to the following scientists whose critical reviews have significantly contributed to the quality of the papers in this special issue.

Emanuel, M., Fredericton, NB, Canada
Pan, W-P., Bowling Green, KY, USA
Handa, P., Pittsford, N.Y., USA
Rich, M., East Lansing, MI, USA
Keating, M., Wilmington, DE, USA
Sanborn, W., Chandler, AZ, USA
Kwok, Q., Ottawa, ON, Canada
Simon, P., Bratislava, Slovak Republic

Krutosikova, A, Bratislava, Slovak Republic
Stroe, D., Pittsburgh, PA, USA
Lan, T., Arlington Heights, IL, USA
Varshney, K.G., Aligarh, India
Laye, P., Leeds, UK
Verenkar, V.M.S., Goa, India
Lee, C. Y-C., Arlington, VA, USA